## 8V to 60V Smart Dual 1.5A Circuit Breaker with Accurate Current Monitoring

### **General Description**

The MAX15162/MAX15162A devices are dual-channel, circuit-breaker ICs. The devices integrate a dual-channel controller with dual  $140m\Omega$  (in WLP,  $180m\Omega$  in TQFN) power MOSFETs and electronic circuit-breaker protection in a single package.

These devices feature constant power control during start-up to keep the MOSFET operating under Safe Operating Area (SOA). The devices provide robust overcurrent protection with programmable current-limit level, and adjustable overcurrent shutdown delay for better immunity against system noises and load transient. The current monitoring pins provide a current sense accuracy of ±3% for each channel. When there is short-circuit at the output, a fast current limit comparator turns off MOSFETs within 200ns to isolate the load from the input. During a fault condition, the MAX15162A enters auto-retry mode and the MAX15162 enters latch off mode. For both devices, the ALRT pin asserts a fault indication. The MAX15162/MAX15162A can be configured as two independent channels or two parallel channels for one common output.

The devices feature a number of protection features including; IN-to-OUT short-circuit protection, output short-circuit protection, startup watchdog timer, input undervoltage lockout and internal overtemperature protection.

The MAX15162/MAX15162A are available in a 24-pin, 4mm x 4mm TQFN package and 16-bump, 2mm x 2mm WLP package and are rated over the -40°C to +105°C operation temperature range.

### **Applications**

- · Radio Access Point System
- Communication
- Industrial

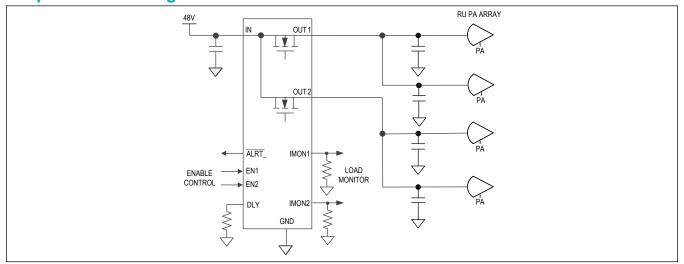
### **Benefits and Features**

- 8V to 60V Wide Input Voltage Range
- Integrated Dual-Power MOSFET
- Turn-On Resistance 140mΩ (WLP), 180mΩ (TQFN) MOSFET
- Dual-Channel Independent or Parallel Mode Configuration
- ± 3% Accuracy Current Reporting on Individual Channel
- Enable Inputs for Individual Channels
- Constant Power Control at Startup
- Startup Watchdog Timer
- Startup IN-to-OUT Short Protection
- Undervoltage-Lockout
- Overcurrent and Overtemperature Fault Status indication
- Multilevel Overcurrent Limit Protection
- Built in Thermal Shutdown Protection
- Programmable Current Limiting Level
- Programmable Overcurrent Shut-down Delay time
- Programmable Auto-Retry Time (MAX15162A)
- Latch Off in a Fault Event (MAX15162)
- Auto-retry in a Fault Event (MAX15162A)
- 24-pin, 4mm x 4mm TQFN or 16-bump, 2mm x 2mm WLP

Ordering Information appears at end of data sheet.



## **Simplified Block Diagram**



## **TABLE OF CONTENTS**

| General Description                                 | 1  |
|---|----|
| Applications  | 1  |
| Benefits and Features                               | 1  |
| Simplified Block Diagram                            | 2  |
| Absolute Maximum Ratings                            | 7  |
| Package Information                                 | 7  |
| WLP   | 7  |
| 24 TQFN   | 7  |
| Electrical Characteristics                          | 8  |
| Typical Operating Characteristics                   | 10 |
| Pin Configurations                                  | 12 |
| 16 WLP  | 12 |
| 24 TQFN   | 12 |
| Pin Description                                     | 13 |
| Functional Diagrams                                 | 14 |
| Block Diagram                                       | 14 |
| Timing Diagram                                      |    |
| Detailed Description                                | 16 |
| Overview  |    |
| Startup   | 16 |
| Startup in Overload or Short-Circuit Condition      | 16 |
| Undervoltage Lockout (UVLO)                         | 16 |
| Input Debounce Protection                           | 17 |
| Enable  | 17 |
| IN-to-OUT Short-Circuit Protection                  | 17 |
| Overcurrent and Short-Circuit Protection            |    |
| Current-Limit Threshold and Current Monitor (IMON_) | 19 |
| Overcurrent Response and Shutdown Delay (DLY)       | 20 |
| ALRT_ Response                                      | 21 |
| Independent and Parallel Mode                       | 21 |
| Fault Auto-Retry and Latch Off                      | 21 |
| Thermal Protection                                  | 21 |
| Applications Information                            | 22 |
| IN Capacitor  | 22 |
| OUT Capacitor                                       | 22 |
| Output Diode for Inductive Hard Short to Ground     | 22 |
| Layout and Thermal Dissipation                      | 22 |
| Typical Application Circuits                        | 23 |

# 8V to 60V Smart Dual 1.5A Circuit Breaker with Accurate Current Monitoring

| TABLE OF CONTENTS (CONTINUED)                |    |  |  |  |
|--|----|--|--|--|
| Typical Application Circuit—Independent Mode | 23 |  |  |  |
| Typical Application Circuit—Parallel Mode    | 23 |  |  |  |
| Ordering Information                         | 24 |  |  |  |
| Revision History                             | 25 |  |  |  |

# 8V to 60V Smart Dual 1.5A Circuit Breaker with Accurate Current Monitoring

| LIST OF FIGURES                                   |    |  |  |
|---|----|--|--|
| Figure 1. Input Debounce Protection               |    |  |  |
| Figure 2. Overcurrent Event                       | 18 |  |  |
| Figure 3. Fast Overcurrent Event                  | 19 |  |  |
| Figure 4. Overcurrent Response and Shutdown Delay | 20 |  |  |

# 8V to 60V Smart Dual 1.5A Circuit Breaker with Accurate Current Monitoring

| LIST OF TABLES  |    |
|---|----|
| Fable 1. R <sub>IMON</sub> Settings for Overcurrent Limit in Independent Mode | 19 |
| Fable 2. R <sub>IMON</sub> Settings for Overcurrent Limit in Parallel Mode    | 19 |
| Table 3. RDLY    Settings for Delay Time and Auto-Retry Time—MAX15162A        | 20 |

## **Absolute Maximum Ratings**

| IN_ to GND0.3V to +65V                             | WLP (Derate 20.4mW/°C above +70°C)1632mW |
|--|--|
| OUT_ to GND1V to (IN_+ 0.3)V                       | Junction Temperature+150°C               |
| EN_, ALRT_, IMON_, DLY to GND0.3 V to +6V          | Storage Temperature Range40°C to +150°C  |
| Operating Junction Temperature Range40°C to +125°C | Lead Temperature (soldering, 10s)+300°C  |
| TQFN (Derate 25.6 mW/°C above +70°C)               | Soldering Temperature (reflow)+240°C     |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **Package Information**

#### **WLP**

| Package Code                           | W161M1+1                       |  |  |
|--|--------------------------------|--|--|
| Outline Number                         | <u>21-100353</u>               |  |  |
| Land Pattern Number                    | Refer to Application Note 1891 |  |  |
| Thermal Resistance, Four-Layer Board:  |                                |  |  |
| Junction to Ambient (θ <sub>JA</sub> ) | 49°C/W                         |  |  |
| Junction to Case (θ <sub>JC</sub> )    | 9.45°C/W                       |  |  |

### **24 TQFN**

| Package Code                           | T2444+2C |  |  |  |
|--|----------|--|--|--|
| Outline Number                         | 21-0139  |  |  |  |
| Land Pattern Number                    | 90-0020  |  |  |  |
| Thermal Resistance, Four-Layer Board:  |          |  |  |  |
| Junction to Ambient (θ <sub>JA</sub> ) | 39°C/W   |  |  |  |
| Junction to Case (θ <sub>JC</sub> )    | 6°C/W    |  |  |  |

For the latest package outline information and land patterns (footprints), go to <a href="https://www.maximintegrated.com/packages">www.maximintegrated.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <a href="https://www.maximintegrated.com/thermal-tutorial">www.maximintegrated.com/thermal-tutorial</a>.

### **Electrical Characteristics**

 $(V_{IN} = 8V \text{ to } 60V, T_A = -40^{\circ}\text{C to } + 105^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at } V_{IN} = 48V, \ C_{OUT} = 22\mu\text{F}, T_A = \ +25^{\circ}\text{C}, R_{IMON1} = 3.01\text{k}\Omega, R_{IMON2} = 3.01\text{k}\Omega, R_{DLY} = 68\text{k}\Omega \text{ (Note 1))}$ 

| PARAMETER                            | SYMBOL               | COND   | ITIONS   | MIN  | TYP   | MAX  | UNITS |
|--------------------------------------|----------------------|--|--|------|-------|------|-------|
| POWER SUPPLY                         |                      | •  | '  |      |       |      | ,     |
| IN Voltage Range                     | V <sub>IN</sub>      |  |  | 8    |       | 60   | V     |
| Shutdown Input Current               | I <sub>SHDN</sub>    | V <sub>EN1</sub> = 0V, V <sub>EN2</sub> = 0                              | OV, V <sub>IN</sub> = 48V  |      | 32    | 90   | μA    |
| Shutdown OUT Current                 | loff                 | V <sub>EN1</sub> = V <sub>EN2</sub> = 0V;<br>V <sub>OUT</sub> = 0.1V;    | T <sub>A</sub> = +25°C   | -2   |       |      | μA    |
| Supply Current                       | I <sub>IN</sub>      | V <sub>IN</sub> = V <sub>OUT</sub> = 48V,                                |  |      | 0.88  | 1.5  | mA    |
| UVLO                                 |                      |  |  |      |       |      |       |
| LIV/I O Trip I aval                  |                      | V <sub>IN</sub> falling, UVLO trip                                       | point  |      | 7.1   |      |       |
| UVLO Trip Level                      | V <sub>UVLO</sub>    | V <sub>IN</sub> rising   |  |      | 7.58  | 7.9  | V     |
| UVLO Hysteresis                      |                      |  |  |      | 500   |      | mV    |
| EN_                                  |                      |  |  |      |       |      | 1     |
| EN_ Input Logic-High                 | V <sub>EN_IH</sub>   |  |  | 1.4  |       |      | V     |
| EN_ Input Logic-Low                  | V <sub>EN IL</sub>   |  |  |      |       | 0.4  | V     |
| EN_ Pullup Voltage                   | V <sub>EN_PUP</sub>  | EN_ pin unconnecte   | d, V <sub>IN</sub> = 60V   |      |       | 2.35 | V     |
| EN_ Input Current                    | I <sub>EN IN</sub>   | V <sub>EN</sub> = 5.5V   |  |      |       | +1   | μA    |
| EN_ Pullup Current                   | I <sub>EN_PUP</sub>  | V <sub>EN</sub> _ = 0.4V   |  | 1    | 4.5   | 12   | μA    |
| INTERNAL FETS                        |                      |  |  |      |       |      | •     |
| Internal FETs On-                    | al FETs On-          |  | V <sub>IN</sub> ≥ 10V, I <sub>OUT</sub> = 100mA, T <sub>A</sub> = +25°C,<br>TQFN Package |      | 180   |      | 0     |
| Resistance                           | R <sub>DSON</sub>    | $V_{IN} \ge 10V$ , $I_{OUT} = 100$ mA, $T_A = +25$ °C, WLP Package       |  |      | 140   |      | mΩ    |
| CURRENT LIMIT                        |                      |  |  |      |       |      | 1     |
| Current Limit Range                  | I <sub>LIM</sub>     |  |  | 0.5  |       | 1.5  | Α     |
| Current Limit Accuracy               | I <sub>LIM_ACC</sub> | T <sub>A</sub> = -40°C to<br>105°C                                       | 0.5A ≤ I <sub>LIM_ACC</sub> ≤ 1.5A   | -5   |       | +5   | %     |
| Fast Current Limit<br>Range          | lliM_F               | 133% x I <sub>LIM</sub>  |  | 0.66 |       | 2    | А     |
| Fast Current Limit<br>Accuracy       |                      | 0.66A ≤ I <sub>LIM_F</sub> ≤ 2A  |  | -10  |       | +10  | %     |
| Fast Current Limit Shut<br>Down Time | T <sub>LIM_F</sub>   |  |  |      | 200   |      | ns    |
| Average Inrush Current               | I <sub>INRUSH</sub>  | During initial turn-on period, V <sub>IN</sub> - V <sub>OUT</sub> > 0.7V |  |      | 28    |      | mA    |
| IMON_                                | <b>.</b>             |  |  |      |       |      | 1     |
| IMON_ Reference                      | V <sub>REF</sub>     |  |  |      | 1.125 |      | V     |
| Current-Mirror Output<br>Ratio       | C <sub>IRATIO</sub>  | 0.05A ≤ I <sub>OUT</sub> ≤ 1.5A  | 0.05A ≤ I <sub>OUT</sub> ≤ 1.5A  |      | 4000  |      | A/A   |

## **Electrical Characteristics (continued)**

 $(V_{IN}=8V~to~60V,~T_A=-40^{\circ}C~to~+105^{\circ}C,~unless~otherwise~noted.~Typical~values~are~at~V_{IN}=48V,~C_{OUT}=22\mu F,~T_A=~+25^{\circ}C,~R_{IMON1}=3.01k\Omega,~R_{IMON2}=3.01k\Omega,~R_{DLY}=68k\Omega~(Note~1))$ 

| PARAMETER                           | SYMBOL                 | COND  | CONDITIONS                              |       | TYP                        | MAX   | UNITS |
|-------------------------------------|------------------------|---|---|-------|----------------------------|-------|-------|
| Current Conce Accurrent             | 1                      | T <sub>A</sub> = -40°C to                       | 0.05A ≤ I <sub>SENS_ACC</sub><br>< 0.5A | -12.5 |                            | +12.5 | - %   |
| Current Sense Accuracy              | ISENS_ACC              | +105°C  | 0.5A ≤ I <sub>SENS_ACC</sub><br>≤ 1.5A  | -3    |                            | +3    | 70    |
| IMON_ Leakage Current               | I <sub>IMON_L</sub>    | V <sub>EN1</sub> = V <sub>EN2</sub> = 0V        |   | -1    |                            | +1    | μA    |
| TIMING                              |                        |   |   |       |                            |       |       |
| Startup Watchdog<br>Timeout         | T <sub>SU</sub>        |   |   |       | 250                        |       | ms    |
| Switch Turn-On Time                 | T <sub>ON_SWITCH</sub> | V <sub>IN</sub> = 48V, C <sub>OUT</sub> = 2     | 22µF                                    |       | 37                         |       | ms    |
| IN Debounce Time                    | T <sub>DEB</sub>       | V <sub>IN</sub> > V <sub>IN_UVLO</sub> and      | EN = High                               |       | 16                         |       | ms    |
|                                     |                        | R <sub>DLY</sub> = 0                            |   |       | 7 12                       | 17    | - µs  |
| Current Limit Delay                 | Toolog                 | $T_{DELAY}$ $R_{DLY} = 28kΩ$ $R_{DLY} = 47.5kΩ$ |   | 80    | 110                        | 130   |       |
| Time                                | DELAY                  |   |   | 0.8   | 1                          | 1.2   | ms    |
|                                     |                        | $R_{DLY} = 68.1k\Omega$                         |   | 8     | 10                         | 12    | 1115  |
| Auto-retry Time                     | T <sub>RETRY</sub>     |   |   |       | 60 X<br>T <sub>DELAY</sub> |       | ms    |
| ALRT                                |                        |   |   |       |                            |       |       |
| ALRT De-assertion<br>Threshold      | VALRT                  | Measured V <sub>IN</sub> - V <sub>OL</sub>      | ΙΤ                                      |       | 2.1                        |       | V     |
| ALRT Assertion Delay                | TALRT                  | I <sub>OUT</sub> reaches Currer                 | nt Limit                                |       | 6                          |       | us    |
| ALRT Output Low<br>Voltage          | VALRT_OL               | Low-Impedance Sta                               | te, I <sub>ALRT</sub> = 1mA             |       |                            | 0.4   | V     |
| ALRT Output High<br>Leakage Current | I <del>ALRT</del> _OH  | High-Impedance State, V <sub>ALRT</sub> = 5.5V  |   |       | 1                          |       | uA    |
| THERMAL PROTECTION                  |                        |   |   |       |                            |       |       |
| Thermal Shutdown                    | T <sub>J_MAX</sub>     |   |   |       | 156                        |       | °C    |
| Thermal-Shutdown<br>Hysteresis      |                        |   |   |       | 20                         |       | °C    |

Note 1: All devices are 100% production tested at  $T_A$  = +25°C. Limits over the operating-temperature range are guaranteed by design; not production tested.

-20

-40

0

20

40 60 80

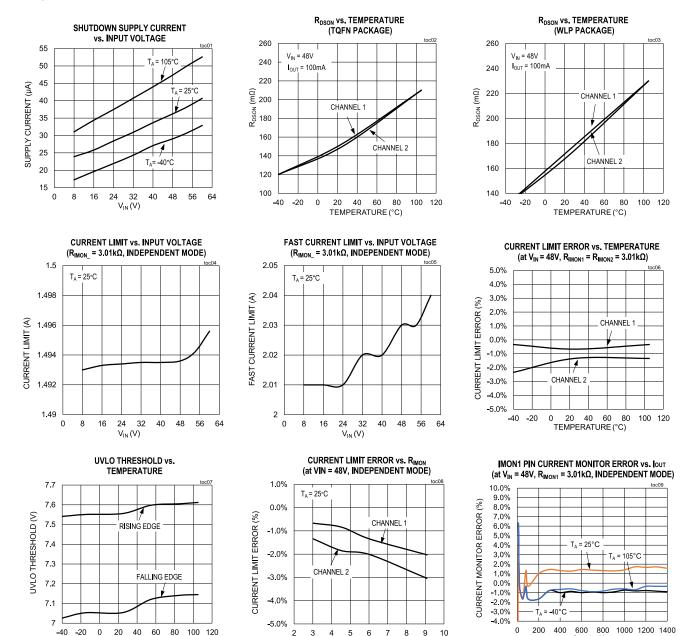
TEMPERATURE (°C)

100 120

## 8V to 60V Smart Dual 1.5A Circuit Breaker with **Accurate Current Monitoring**

### **Typical Operating Characteristics**

 $(V_{IN} = 8V \text{ to } 60V, T_A = -40^{\circ}\text{C to } + 105^{\circ}\text{C}, C_{OUT} = 4 \text{ x } 4.7 \mu\text{F per channel}, V_{EN1} = 3.3V, V_{EN2} = 3.3V, ALRT = OPEN, R_{IMON1} = 3.01 k\Omega, ALRT = OPEN, ALRT$  $R_{IMON2} = 3.01k\Omega$ ,  $R_{DLY} = 68k\Omega$ . Unless otherwise noted.)



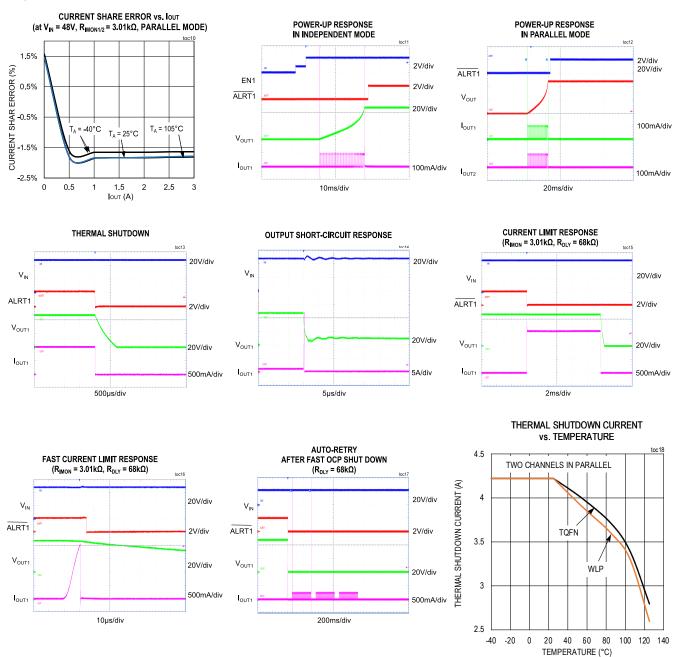
Maxim Integrated | 10 www.maximintegrated.com

5

8

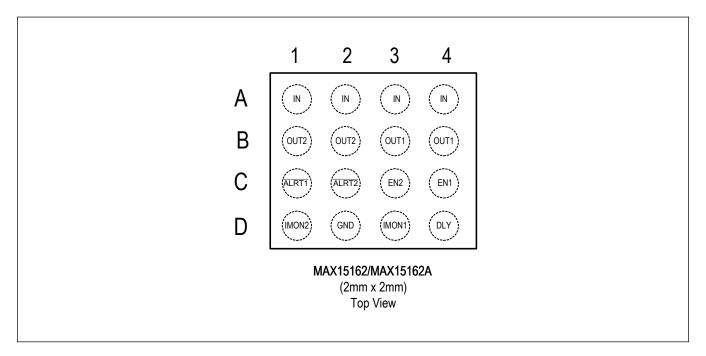
## **Typical Operating Characteristics (continued)**

 $(V_{IN}=8V~to~60V,~T_A=-40^{\circ}C~to~+105^{\circ}C,~C_{OUT}=4~x~4.7\mu F~per~channel,~V_{EN1}=3.3V,~V_{EN2}=3.3V,~ALRT=OPEN,~R_{IMON1}=3.01k\Omega,~R_{IMON2}=3.01k\Omega,~R_{DLY}=68k\Omega.~Unless~otherwise~noted.)$ 

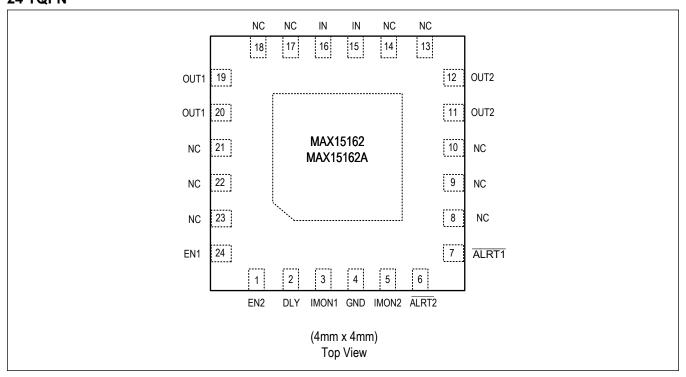


## **Pin Configurations**

### **16 WLP**



### **24 TQFN**

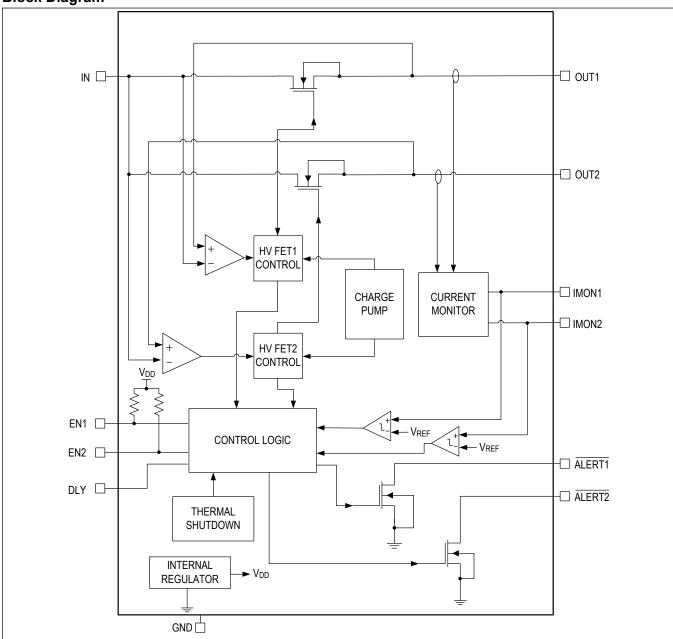


## **Pin Description**

| Pi                | PIN     |       |  |  |
|-------------------|---------|-------|--|--|
| 16 WLP            | 24 TQFN | NAME  | FUNCTION   |  |
| A1, A2, A3,<br>A4 | 15,16   | IN    | Supply Voltage Input. IN is connected to the drain of internal MOSFET. Apply at least 1µF capacitor at IN. Bypass IN with a transient voltage-suppressor diode to GND for clamping inductive transients in the case of fast output short event.  |  |
| B3, B4            | 19, 20  | OUT1  | Power Output 1. Source of the internal power MOSFET1. In parallel mode It shall be connected to OUT2 to scale the current capability.  |  |
| B1, B2            | 11, 12  | OUT2  | Power Output 2. Source of the internal power MOSFET2. In parallel mode, it should be connected to OUT1 to scale the current capability.  |  |
| D3                | 3       | IMON1 | Current Limit Threshold Setting and Current Monitor Output for Channel 1. This pin sources a scaled-down internal MOSFET current. Connect a resistor to GND to set current limit threshold between 0.5A and 1.5A, and convert current to voltage for current motoring. This pin can not be floating.                                   |  |
| D1                | 5       | IMON2 | Current Limit Threshold Setting and Current Monitor Output for Channel 2. This pin sources a scaled-down internal MOSFET current. Connect a resistor to GND to set current limit threshold between 0.5A and 1.5A, and convert current to voltage for current motoring. This pin can not be floating.                                   |  |
| C4                | 24      | EN1   | Active-High Enable Input 1. Internally pulled up to 2V. The pin can be also externally pulled up to logic-high state to enable the output 1.   |  |
| СЗ                | 1       | EN2   | Active-High Enable Input 2. Internally pulled up to 2V. The pin can be also externally pulled up to logic-high state to enable the output 2.   |  |
| C1                | 7       | ALRT1 | ALRT1 Status Output for Channel 1. Open-drain output. ALRT1 pin de-asserts when the channel 1 MOSFET is fully turned on. ALRT1 pin asserts when these events occur—output 1 is disabled, current limit event, overtemperature event, startup watchdog timer times out, startup configuration fault. Leave ALRT1 unconnected if unused. |  |
| C2                | 6       | ALRT2 | ALRT2 Status Output for Channel 2. Open-drain output. ALRT2 pin de-asserts when the channel 2 MOSFET is fully turned on. ALRT2 pin asserts when these events occur—output 2 is disabled, current limit event, overtemperature event, startup watchdog timer times out, startup configuration fault. Leave ALRT2 unconnected if unused. |  |
| D4                | 2       | DLY   | Overcurrent Shutdown Delay Setting. Connect a resistor to GND to configure shut down delay to be 12µs, 100µs, 1ms, 10ms in current limit event.  |  |
| D2                | 4       | GND   | Ground.  |  |
| _                 | _       | EP    | Exposed Pad. Connect EP to a large GND plane with several thermal vias for best thermal performance. Refer to the MAX15162 EV kit data sheet for a reference layout design.  |  |

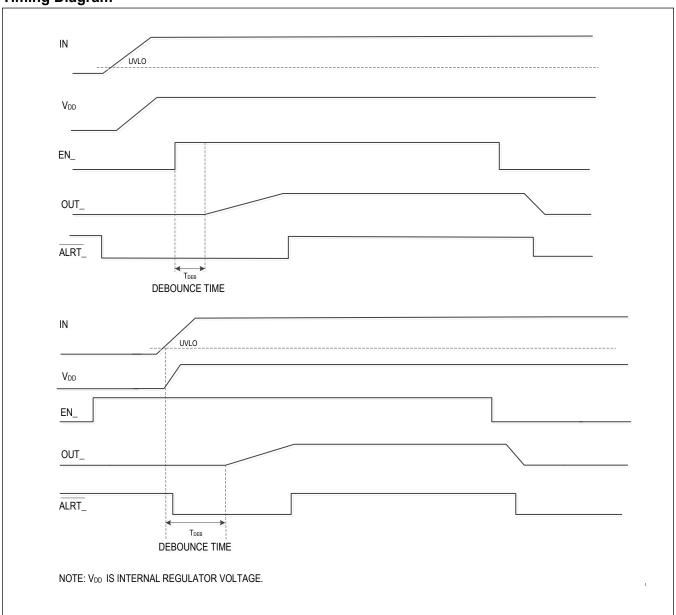
## **Functional Diagrams**

## **Block Diagram**



## **Functional Diagrams (continued)**

## **Timing Diagram**



### **Detailed Description**

### Overview

The MAX15162/MAX15162A are 8V to 60V integrated, dual-channel circuit breaker devices. The dual channels can be configured as independent mode, or parallel mode to scale up the current capability. The devices feature constant power control during startup process to ensure MOSFETs operating under Safe Operating Area (SOA). The programmable current limit and adjustable shutdown time for current limit event provide flexibility for various applications with different power levels. The fast overcurrent protection can shut down the MOSFET within 200ns when a larger current or short-circuit occurs at the output. The ±3% current monitoring over the input and temperature change can provide accurate current information to the system. The ALRT response indicates the output and fault status, and it asserts when

- The output is disabled
- Current limit occurs
- Overtemperature occurs
- Startup watchdog times out
- · Configuration fault occurs.

The active-high EN pin functions make enable/disable easy to control. The input and EN debounce protection prevent the MOSFET turning on from noisy or transitioning input or EN signals. The IN-to-OUT short-circuit protection prevents the MOSFET from turning on when the MOSFET is shorted or the input and output are in shorted condition. The devices provide a choice of auto-retry or latch-off mode during fault events based on MAX15162A or MAX15162.

### **Startup**

The devices are designed to power-up the output with constant power control by actively monitoring the MOSFET power and limiting the startup current. The startup current is a series of pulsating current whose duty cycles are controlled by constant power limit circuit. The averaged startup current with constant power control is approximately 28mA. This scheme is to ensure the internal MOSFET operate within SOA during the startup. Once the output ramps up to be within 700mV of the input voltage, the MOSFET is switched to constant current control to expedite the startup process. When the MOSFET is fully turned on, the current limit is switched to programmable normal operation current limit threshold.

An internal watch<u>dog</u> timer starts counting when the devices enter the startup phase. The devices complete the startup phase, de-assert  $\overline{ALRT}$  pin and enter normal operation mode once  $V_{IN}$  -  $V_{OUT}$  < 700mV. If the watchdog timer elapses and  $V_{IN}$  -  $V_{OUT}$  is still greater than 700mV, the MOSFET will be turned off and the devices enter auto-retry mode in the MAX15162A or latch mode in the MAX15162. When the auto-retry time elapses the part will restart the power-up process. The thermal-protection circuit is always active and the MOSFET will be immediately turned off when the thermal-shutdown threshold is reached.

### Startup in Overload or Short-Circuit Condition

When the device powers up the MOSFET with a very large load or short circuit at the output, the duty cycles of the pulsating startup current is limited to initial values to ensure the power dissipation is not overheating the device. While the output is shorted to GND, the MOSFET will be turned off once the startup watchdog timer times out in 250ms. The device then restarts the power-up process in auto-retry mode (MAX15162A), or latches off the MOSFET until EN is toggled or the input is cycled to cross UVLO (MAX15162).

### **Undervoltage Lockout (UVLO)**

The devices feature an undervoltage lockout functionality. When the input voltage falls below  $V_{UVLO}$  the internal MOSFET is turned off immediately and  $\overline{ALRT}$  pin asserts to indicate the fault condition. The UVLO comparator has a hysteresis of 500mV (typ).

### **Input Debounce Protection**

The devices feature an input debounce protection in startup process to prevent the MOSFET from turning on from noisy and transitioning input. The devices start to ramp up the output (turn on the internal MOSFETs) only when the input voltage is higher than UVLO threshold and EN is pulled high for a period that is greater than the debounce time ( $T_{DEB}$ ). The  $T_{DEB}$  time elapses only at startup process.

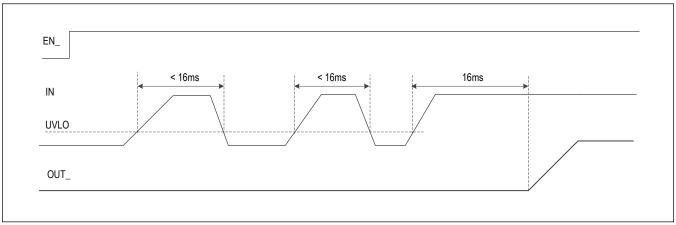


Figure 1. Input Debounce Protection

#### **Enable**

The dual MOSFETs can be individually enabled or disabled through EN\_ pin by externally driving it above or below the EN\_ threshold voltage. To enable the device EN\_ pins must be pulled up to at least 1.4V or left floating. The external driving voltage can be as high as 5V. EN\_ pins are default active-high with internal 2V pullup circuit, even when they are floated. The EN pins also have debounce protection to prevent the MOSFET from turning on by noise glitches on EN\_ pins. If the device is configured to be parallel mode, two EN pins are required to tie together externally. When both EN\_ pins are pulled to below 0.4V, externally the device shutdown current reduces to 32µA in low current shutdown mode.

### **IN-to-OUT Short-Circuit Protection**

At startup, after the MOSFET is enabled without any faults, the device immediately checks for an IN-to-OUT short-circuit fault. If  $V_{\text{IN}}$  -  $V_{\text{OUT}}$  is less than a threshold (700mV), the internal MOSFET turns off and the device enters latch off mode (MAX15162) or auto-retry mode (MAX15162A). This is to prevent the MOSFET from turning on in shorted  $V_{\text{IN}}$  to  $V_{\text{OUT}}$  or shorted MOSFET condition.

### **Overcurrent and Short-Circuit Protection**

Overcurrent fault protection is enabled in normal operation after the startup process with comparators for normal current limit threshold and fast current limit threshold. Overcurrent limit level can be configured through IMON\_ pins for each MOSFET. The current limit comparator is designed so the load current can exceed the threshold for a programmable delay time prior to shut down the MOSFET. The delay time can be configured through DLY pin by connecting a resistor to GND (see <u>Table 3</u>).

During an overcurrent event, the ALRT pin asserts once the current limit threshold is tripped. The device turns off the internal MOSFET and disconnects the output from the input once the delay time elapses (see <u>Figure 2</u>). The device then operates in either auto-retry mode and restarts the output after a T<sub>RETRY</sub> delay elapses (MAX15162A) or enters latch mode and latches off the output until EN is re-enabled or the input is cycled to cross UVLO threshold (MAX15162).

The devices also feature catastrophic fast overcurrent protection for large load event or short circuit condition. During normal operation, if the output is shorted to the ground or a very large current with high slope rate (di/dt) occurs, once the current reaches fast current limit comparator threshold (133% of normal current limit), a fast protection circuit forces the gate of the MOSFET to discharge rapidly and disconnect the output from the input in 200ns (see <u>Figure 3</u>).

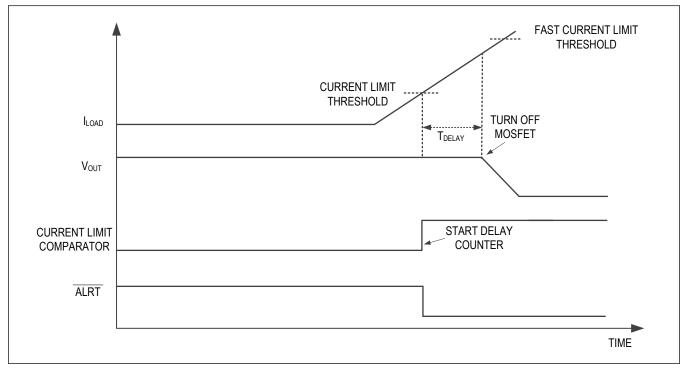


Figure 2. Overcurrent Event

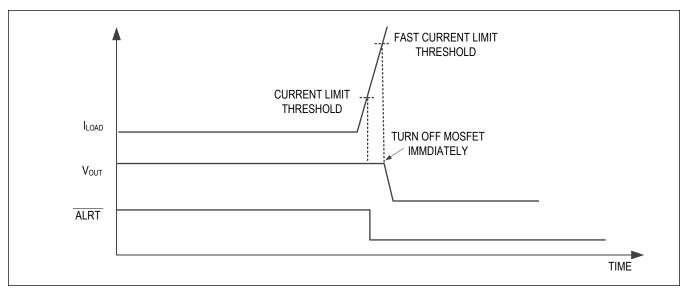


Figure 3. Fast Overcurrent Event

### Current-Limit Threshold and Current Monitor (IMON\_)

Connect a resistor between IMON\_ and GND to program the current limit thresholds of the devices. Use the following equation to calculate current limit setting resistor  $R_{IMON}$  for independent mode:

$$R_{IMON}$$
 ( $\Omega$ ) = 1.125 x  $C_{IRATIO}/I_{LIM}$  (A)

In parallel mode, connect IMON1 and IMON2 pins together with one resistor to GND, and use the following equation to calculate current limit setting resistor  $R_{IMON}$ :

$$R_{IMON}$$
 ( $\Omega$ ) = 1.125 x  $C_{IRATIO}/I_{LIM}$  (A)/2

Where  $I_{LIM}$  is the desired current limit in A, and  $C_{IRATIO}$  is current sensing ratio (4000, typ). <u>Table 1</u> and <u>Table 2</u> show  $R_{IMON}$  resistor settings for normal overcurrent limits and fast overcurrent limits for in independent and parallel mode respectively.

Table 1. R<sub>IMON</sub> Settings for Overcurrent Limit in Independent Mode

| R <sub>IMON</sub> (ΚΩ)<br>IN INDEPENDENT MODE | CURRENT LIMIT/CHANNEL (A) | FAST OCP LIMIT/CHANNEL (A) |
|---|---------------------------|----------------------------|
| 9.09  | 0.50                      | 0.66                       |
| 6.04  | 0.75                      | 0.99                       |
| 4.53  | 0.99                      | 1.32                       |
| 3.01  | 1.50                      | 1.99                       |

Table 2. R<sub>IMON</sub> Settings for Overcurrent Limit in Parallel Mode

| R <sub>IMON_</sub> (KΩ) IN PARALLEL MODE | CURRENT LIMIT/ CHANNEL (A) | FAST OCP LIMIT/CHANNEL (A) |
|--|----------------------------|----------------------------|
| 4.53                                     | 0.50                       | 0.66                       |
| 3.01                                     | 0.75                       | 1.00                       |
| 2.26                                     | 1.00                       | 1.33                       |
| 1.50                                     | 1.50                       | 2.00                       |

The devices feature a precise analog read-out of the current. The mirrored current flows out through IMON\_ pins into

external current-limit resistor  $R_{IMON}$ . The voltage on IMON\_ pin  $V_{IMON}$  provides information about the current with the following relationship:

 $I_{OUT}(A) = V_{IMON}(V) \times C_{IRATIO}/R_{IMON}(\Omega)$ 

In independent mode, I<sub>OUT</sub> in above equation represents the current from individual channel. In parallel mode, while connect IMON1 and IMON2 pins together, I<sub>OUT</sub> represents the summed current of two channels.

IMON pins must not be left floating.

### Overcurrent Response and Shutdown Delay (DLY)

When the current flowing through the MOSFET reaches current limit threshold,  $T_{DELAY}$  timer begins to count up, and ALRT pin is asserted. If the current drops back to below current limit threshold then the  $T_{DELAY}$  timer begins to count down, as shown in <u>Figure 4</u>. The timer counting-down speed is slower than counting-up speed. Once the configured  $T_{DELAY}$  time is reached by the timer, the MOSFET is turned off. This mechanism is to prevent the MOSFET from turning off due to high-frequency current ripples or noises through the device.

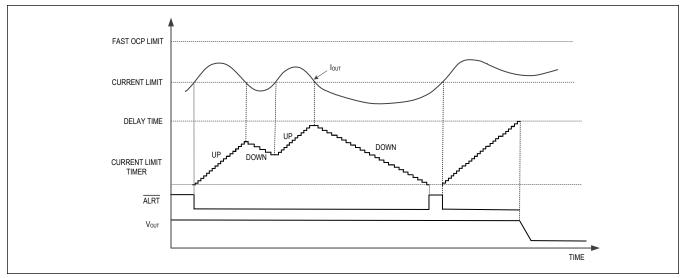


Figure 4. Overcurrent Response and Shutdown Delay

In the MAX15162A, in an overcurrent event, a auto-retry time delay ( $T_{RETRY}$ ) starts immediately after  $T_{DELAY}$  elapses. During  $T_{RETRY}$  time the MOSFET remains off. Once  $T_{RETRY}$  elapses the MOSFET is turned on again. If the fault still exists then the cycle is repeated and ALRT pin remains asserted. If the overcurrent condition is resolved within  $T_{DELAY}$ , the switch stays on. By connecting a resistor to GND on DLY pin to set  $T_{DELAY}$  time and  $T_{RETRY}$  time, as shown in Table 3:

Table 3. R<sub>DLY</sub> Settings for Delay Time and Auto-Retry Time—MAX15162A

| RDLY (KΩ) | DELAY TIME T <sub>DELAY</sub> | AUTO-RETRY TIME T <sub>RETRY</sub> (ms) |
|-----------|-------------------------------|---|
| 0         | 12µs                          | 0.6                                     |
| 28        | 100µs                         | 6                                       |
| 47.5      | 1ms                           | 60                                      |
| 68.1      | 10ms                          | 600                                     |

In the MAX15162, in an overcurrent event after  $T_{DELAY}$  elapses, the MOSFET is turned off and enters latch off mode until EN pin is re-enabled or the input is cycled to cross UVLO.

### **ALRT\_** Response

The devices feature an open-drain, ALRT\_ output as indication of MOSFET fully turning on and fault events. Once the MOSFET is fully enhanced without any faults ALERT\_ pin will be de-asserted and remain de-asserted in MOSFET normal operation. ALERT\_ pin will be asserted when

- MOSFET V<sub>DS</sub> voltage is greater than 2V.
- Input voltage drops to UVLO level.
- Overcurrent limit threshold is tripped.
- Overtemperature threshold is tripped.
- · Startup watchdog timer times out.
- · Startup configuration fault occurs.

In Parallel mode, ALERT\_ pins are driven by status of both MOSFETs. Fault from either channel will assert both ALERT\_ pins.

### **Independent and Parallel Mode**

The devices can be configured as two independent channels or parallel channels for one common output. The device is configured as independent mode if IMON\_pins are separately connecting to two resistors. To configure as parallel mode, two IMON\_ pins are required to tie together and connect to one resistor across IMON\_ to GND, EN1 and EN2 pins are required to tie together, and OUT1 and OUT2 are to be connected together. The device detects IMON\_ pins connection during initialization process and determines independent or parallel channel configuration mode. IMON\_ pins must not be left floating; otherwise, a startup configuration fault occurs.

### Fault Auto-Retry and Latch Off

In a fault condition, the MAX15162A supports auto-retry mode and the MAX15162 supports latch-off mode. When the device turns off the MOSFET due to below fault conditions:

- · Overcurrent event after delay time elapses.
- Fast overcurrent threshold is tripped.
- Output hard short event.
- Startup watchdog timer times out.

After the MOSFET is turned off, the MAX15162A enters auto-retry mode and restarts the power-up process after auto-retry delay time elapses. If the power-up is not successful in 250ms watchdog timeout, it stops and waits till the delay time elapses and starts next power-up. The auto-retry attempts totally 3 times. After three time auto-retries if the power-up is still not successfully the device stops retrying and latches off. In auto-retry mode, the delay time is configured by DLY pin.

The MAX15162 enters latch off mode once the fault events occur and the MOSFET is turned off, and it restarts the power-up process once EN\_ is re-enabled or the input is cycled to cross UVLO.

### **Thermal Protection**

The devices enter a thermal-shutdown mode in the event of overheating caused by excessive power dissipation or high ambient temperature. When the junction temperature exceeds thermal shutdown threshold, the internal thermal-protection circuitry turns off the MOSFET and ALRT\_ asserts to indicate the fault event. When the junction temperature falls below thermal-shutdown threshold hysteresis level, the device restarts the MOSFET power-up process.

### **Applications Information**

### **IN Capacitor**

Place at least a 1µF capacitor from the IN pin to GND to hold input voltage during any transients. If the upstream converter is too far away from the MAX15162, more input capacitors are recommended to be added to stabilize input voltage due to sudden load-current changes or MOSFET fast turn-off.

### **OUT Capacitor**

The maximum capacitive load ( $C_{MAX}$ ) that can be connected is a function of average startup current ( $I_{INRUSH}$ ), the watchdog time ( $T_{SU}$ ) and the input voltage ( $V_{IN}$ ).  $C_{MAX}$  can be calculated using the following relationship:

$$C_{MAX}(\mu F) = \frac{I_{INRUSH}(mA) \times T_{SU}(ms)}{V_{IN}(V)}$$

Equation 1: Maximum Output Capacitor

For example, for  $V_{IN}$  = 48V,  $T_{SU}$  = 250ms, and  $I_{INRUSH}$  = 28mA,  $C_{MAX}$  is 146 $\mu$ F.

Output capacitor values in excess of C<sub>MAX</sub> can result in a longer charging period and startup time, hence the possibility of watchdog timeout fault. Since the startup process is constant power limited, excessive capacitors will not cause more power dissipation or thermally stress the device.

### **Output Diode for Inductive Hard Short to Ground**

In applications that require protection from a sudden short to ground with an inductive load or a long cable, a diode between the OUT terminal and ground is recommended. This is to prevent a negative spike on the OUT due to the inductive kickback during a short-circuit event.

### **Layout and Thermal Dissipation**

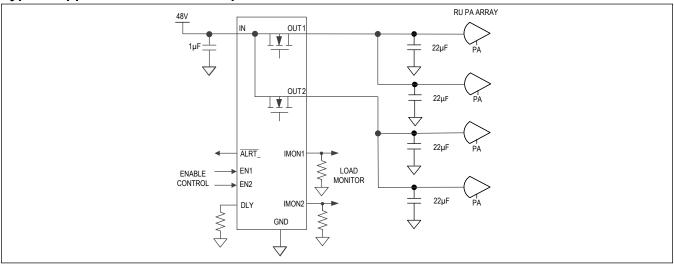
To optimize the switch response time to turn off the output fast during short-circuit conditions, it is very important to keep all traces as short as possible to reduce the effect of undesirable parasitic inductance. Place the device close to the input supply to avoid too much parasitic inductance. Place input capacitors as close as possible to the device (no more than 5mm). Place output capacitors close to the load. If there are protection devices such as TVS, or diodes, they must be placed close to the part with short traces to reduce inductance. IN and OUT must be connected with wide short traces to the power bus.

To allow for the best cooling ability of the TQFN package, the EP (exposed pad) must be soldered directly to the board GND plane. It is highly recommended to apply four 20mil thermal vias on EP to help power dissipation, and reduce thermal resistance to the ambient. On the PCB board, the second layer from top and bottom should be continuous GND plane for electrical and thermal optimization. Place all support components close to connection pins. Connect the components to the GND with shortest trace length. The trace for IMON\_ pin resistor R<sub>IMON1/2</sub> to the device must be as short as possible to reduce parasitic effects on the current limit and current reporting accuracy. Avoid any coupling of switching signals from the board to R<sub>IMON</sub> traces.

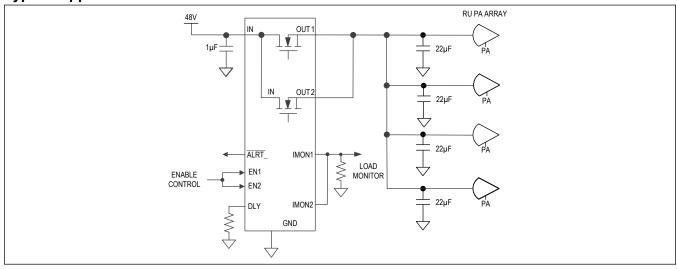
Refer to the MAX15162 EV kit data sheet for a reference layout design.

## **Typical Application Circuits**

## Typical Application Circuit—Independent Mode



## Typical Application Circuit—Parallel Mode



## **Ordering Information**

| PART NUMBER   | FAULT RESPONSE | PIN-PACKAGE |
|---------------|----------------|-------------|
| MAX15162AAWE+ | Auto-Retry     | 16 WLP      |
| MAX15162AWE+  | Latch Off      | 16 WLP      |
| MAX15162AATG+ | Auto-Retry     | 24 TQFN     |
| MAX15162ATG+  | Latch Off      | 24 TQFN     |

<sup>+</sup> Denotes a lead (Pb)-free/RoHS-compliant package.

T = Tape-and-reel.

# 8V to 60V Smart Dual 1.5A Circuit Breaker with Accurate Current Monitoring

## **Revision History**

| REVISION NUMBER | REVISION DATE | DESCRIPTION   | PAGES<br>CHANGED |
|-----------------|---------------|---|------------------|
| 0               | 11/19         | Initial release   | _                |
| 1               | 2/20          | Updated Benefits and Features, Thermal Protection, and Ordering Information | 1, 16, 23        |
| 2               | 3/21          | Updated Absolute Maximum Ratings and Functional Diagrams                    | 2, 13            |

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at https://www.maximintegrated.com/en/storefront/storefront.html.

Maxim Integrated cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim Integrated product. No circuit patent licenses are implied. Maxim Integrated reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.